

Procedure file

Basic information				
DEA - Delegated acts procedure	2013/2905(DEA)	Procedure completed - delegated act enters into force		
Exemption for lead in solders on printed circuit boards, termination coatings of electrical and electronic components and coatings of printed circuit boards, solders for connecting wires and cables, solders connecting transducers and sensors that are used durably at a temperature below 20°C				
Supplementing 2008/0240(COD)				
Subject 3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)				
Documentation gateway				
Non-legislative basic document		C(2013)06798	18/10/2013	EC